MXXIM

White LED Current Regulator with 1x/1.5x **High-Efficiency Charge Pump**

General Description

The MAX1570 fractional charge pump drives up to five white LEDs with regulated constant current for uniform intensity. The MAX1570 maintains the highest possible efficiency over the full 1-cell lithium-ion (Li+) battery input voltage range by utilizing a 1x/1.5x fractional charge pump and very-low-dropout current regulators. The MAX1570 operates with 1MHz fixed-frequency switching, allowing for tiny external components. The regulation scheme is optimized to ensure low EMI and low input ripple.

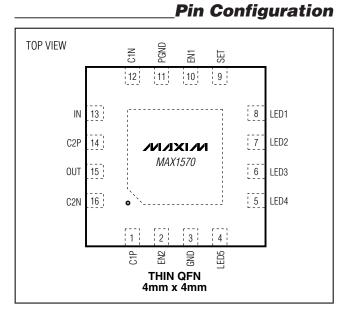
An external resistor sets the full-scale LED current. while two digital inputs control on/off and select between three levels of brightness. A pulse-width modulation (PWM) signal can also be used to modulate LED brightness.

The MAX1570 is available in 16-pin 4mm × 4mm Thin QFN packaging (0.8mm max height).

Applications

White LED Backlighting Cell Phones and Smart Phones PDA and Palmtop Computers Portable MP3 Players

Digital Cameras and Camcorders



For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Features

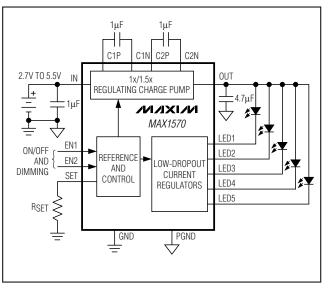
- Excellent 0.3% LED-to-LED Current Matching
- 30mA/LED Drive Capability
- Proprietary 1x/1.5x Modes for Ultra-High Efficiency
- Low Input Ripple and EMI
- Eliminates Ballast Resistors
- Digital or PWM LED Dimming Control
- O.1µA Shutdown Current
- 2.7V to 5.5V Supply Voltage Range
- Soft-Start Limits Inrush Current
- Thermal-Shutdown Protection
- No External Inductor, Schottky, or Zener Diode Required
- Tiny 16-Pin 4mm × 4mm Thin QFN Package

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX1570ETE	-40°C to +85°C	16 Thin QFN

Typical Operating Circuit

Maxim Integrated Products 1



ABSOLUTE MAXIMUM RATINGS

IN, OUT, EN1, EN2 to GND	-0.3V to +6V
SET, LED1, LED2, LED3, LED4,	
LED5 to GND	0.3V to (V _{IN} + 0.3V)
PGND to GND	0.3 to +0.3V
C1N, C2N to GND	0.3V to (V _{IN} + 1V)
C1P, C2P to GND	0.3V to the greater
$(V_{OUT} + 1V)$ or $(V_{IN} + 1V)$	-
OUT Short Circuit to GND	Indefinite

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
16-Pin Thin QFN (derate 16.9 mW/°C)	1349mW
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 3.6V, GND = PGND = 0, EN1 = EN2 = IN, C_{IN} = C1 = C2 = 1\mu$ F, $C_{OUT} = 4.7\mu$ F, **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
IN Operating Voltage		2.7		5.5	V
Undervoltage Lockout Threshold	V _{IN} rising or falling	2.25	2.45	2.60	V
Undervoltage Lockout Hysteresis			35		mV
Supply Current	1MHz switching, no load		2.0	3.5	mA
Shutdown Supply Current	EN1 = EN2 = GND		0.1	5	μA
Soft-Start Done Time			2.1		ms
	EN1 = GND, EN2 = IN, $I_{SET} = 33\mu A$	0.190	0.200	0.210	
SET Bias Voltage	$EN1 = IN, EN2 = GND, I_{SET} = 67 \mu A$	0.380	0.400	0.420	V
	EN1 = IN, EN2 = IN, I _{SET} = 100µA	0.570	0.600	0.630	
SET Leakage in Shutdown	$EN1 = EN2 = GND$, $V_{IN} = 5.5V$, $V_{SET} = 0$ or $5.5V$		0.01	1.00	μA
SET Current Range		20		130	μA
SET to LED_ Current Ratio	I_{LED}/I_{SET} , $I_{SET} = 67\mu A$, $V_{LED} = 1V$	215	230	245	A/A
LED_ to LED_ Current Matching	$I_{SET} = 67 \mu A$, $V_{LED} = 1V$	-3	0.3	+3	%
Maximum LED_ Sink Current	$I_{SET} = 130 \mu A$, $V_{LED} = 1V$	28	30		mA
	I _{SET} = 33µA (Note 1)		100	180	
LED_ Dropout Voltage	I _{SET} = 67µA (Note 2)		200	360	mV
	I _{SET} = 100µA (Note 2)		230	410	
	EN1 = GND, EN2 = IN, $I_{SET} = 33\mu A$	185	200	215	
LED1 Regulation Voltage (1.5x Mode)	$EN1 = IN, EN2 = GND, I_{SET} = 67 \mu A$	277	300	323	mV
(1.5% Wode)	EN1 = IN, EN2 = IN, I _{SET} = 100µA	360	400	440	
LED Leakage in Shutdown	EN1 = GND, EN2 = GND, V_{LED} = 5.5V		0.01	1.00	μΑ
Maximum OUT Current	$IN \ge 3.4V, OUT \ge 3.9V$	150			mA
Open-Loop OUT Resistance	1x mode (V _{IN} - V _{OUT})/I _{OUT}		1.00	1.75	Ω
Open-Loop OOT Resistance	1.5x mode (1.5V _{IN} - V _{OUT})/I _{OUT}			8	52
Switching Frequency			1		MHz
EN1, EN2 High Voltage	IN = 2.7V to 5.5V	1.6			V
EN1, EN2 Low Voltage	IN = 2.7V to 5.5V			0.4	V
EN1, EN2 Input Current	EN_ = GND or 5.5V		0.01	1.00	μA

M/XI/M

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = 3.6V, GND = PGND = 0, EN1 = EN2 = IN, C_{IN} = C1 = C2 = 1\mu$ F, $C_{OUT} = 4.7\mu$ F, **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
LED1 Dual Mode™ Threshold		50	75	100	mV
Thermal-Shutdown Threshold			160		°C
Thermal-Shutdown Hysteresis			20		°C

ELECTRICAL CHARACTERISTICS

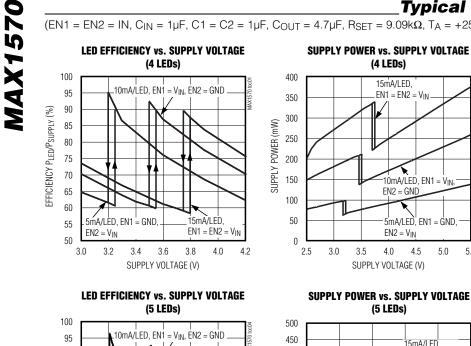
 $(V_{IN} = 3.6V, GND = PGND = 0, EN1 = EN2 = IN, C_{IN} = C1 = C2 = 1\mu$ F, $C_{OUT} = 4.7\mu$ F, **T_A = -40°C to +85°C**, unless otherwise noted.) (Note 3)

PARAMETER	CONDITIONS	MIN	МАХ	UNITS
IN Operating Voltage		2.7	5.5	V
Undervoltage Lockout Threshold	V _{IN} rising or falling	2.25	2.60	V
Supply Current	1MHz switching, no load		3.5	mA
Shutdown Supply Current	EN1 = EN2 = GND		5	μA
	EN1 = GND, EN2 = IN, I_{SET} = 33µA	0.190	0.210	
SET Bias Voltage	$EN1 = IN, EN2 = GND, I_{SET} = 67\mu A$	0.380	0.420	V
	EN1 = IN, EN2 = IN, I _{SET} = 100µA	0.570	0.630	
SET Leakage in Shutdown	$EN1 = EN2 = GND$, $V_{IN} = 5.5V$, $V_{SET} = 0$ or $5.5V$		1	μA
SET Current Range		20	130	μA
SET to LED_ Current Ratio	I _{LED} /I _{SET} , I _{SET} = 67µA, V _{LED} = 1V	215	250	A/A
LED_ to LED_ Current Matching	$I_{SET} = 67 \mu A$, $V_{LED} = 1V$	-3	+3	%
Maximum LED_ Sink Current	$I_{SET} = 130 \mu A, V_{LED} = 1V$	28		mA
	I _{SET} = 33µA (Note 1)		180	
LED_ Dropout Voltage	I _{SET} = 67µA (Note 2)		360	mV
	I _{SET} = 100µA (Note 2)		410	
	EN1 = GND, EN2 = IN, $I_{SET} = 33\mu A$	185	215	
LED1 Regulation Voltage (1.5x Mode)	EN1 = IN, EN2 = GND, $I_{SET} = 67\mu A$	277	323	mV
	EN1 = IN, EN2 = IN, I _{SET} = 100µA	360	440	
LED Leakage in Shutdown	$EN1 = GND, EN2 = GND, V_{LED} = 5.5V$		1	μA
Maximum OUT Current	$IN \ge 3.4V, OUT \ge 3.9V$	150		mA
Open Leon OLIT Registeres	1x mode (V _{IN} - V _{OUT})/I _{OUT}		1.75	0
Open-Loop OUT Resistance	1.5x mode (1.5V _{IN} - V _{OUT})/I _{OUT}		8	Ω
EN1, EN2 High Voltage	IN = 2.7V to 5.5V	1.6		V
EN1, EN2 Low Voltage	IN = 2.7V to 5.5V		0.4	V
EN1, EN2 Input Current	EN_ = GND or 5.5V		1	μA
LED1 Dual Mode Threshold		50	100	mV

Note 1: Dropout voltage is defined as the LED_ to GND voltage at which current sink into LED_ drops 20% from the value at LED_ = 1V. **Note 2:** Dropout voltage is defined as the LED_ to GND voltage at which current sink into LED_ drops 10% from the value at LED_ = 1V. **Note 3:** Specifications to -40°C are guaranteed by design and not production tested.

Dual Mode is a trademark of Maxim Integrated Products, Inc.

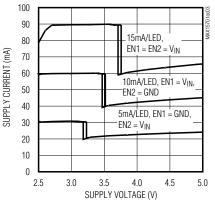


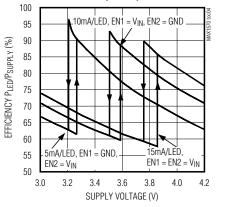


Typical Operating Characteristics

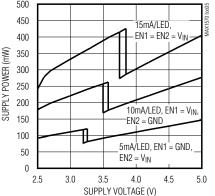
(EN1 = EN2 = IN, C_{IN} = 1µF, C1 = C2 = 1µF, C_{OUT} = 4.7µF, R_{SET} = 9.09k Ω , T_A = +25°C, unless otherwise noted.)

SUPPLY CURRENT vs. SUPPLY VOLTAGE (4 LEDs)

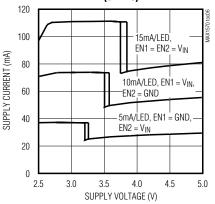




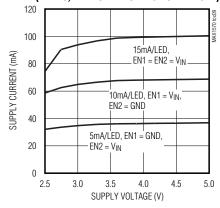
5.5



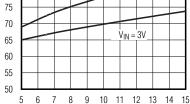
SUPPLY CURRENT vs. SUPPLY VOLTAGE (5 LEDs)



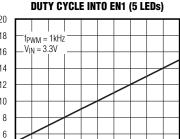
SUPPLY CURRENT vs. SUPPLY VOLTAGE (4 LEDs, LED1 OPEN FOR 1.5X ONLY MODE)



EFFICIENCY vs. LED CURRENT LED CURRENT vs. PWM DIMMING (4 LEDs, EN1 = PWM AT 1kHz) 20 18 16 14 LED CURRENT (mA) $V_{IN} = 3.9V$ 12 10 8 V_{IN} = 3V



LED CURRENT (mA)



30 40 50 60 70

PWM DUTY CYCLE (%)

4

2 0

0 10 20



80 90 100



100

95

90

85

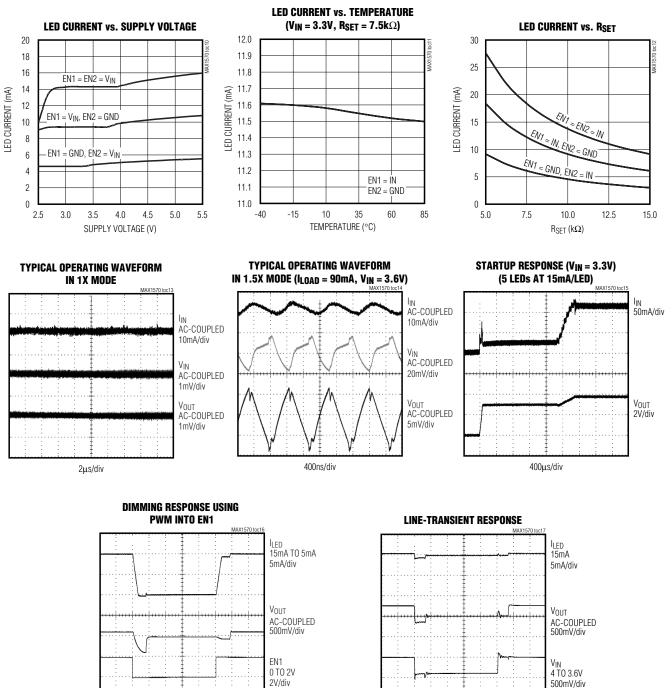
80

EFFICIENCY PLED/PSUPPLY (%)

Typical Operating Characteristics (continued)

100µs/div

(EN1 = EN2 = IN, $C_{IN} = 1\mu$ F, $C1 = C2 = 1\mu$ F, $C_{OUT} = 4.7\mu$ F, $R_{SET} = 9.09k\Omega$, $T_A = +25^{\circ}C$, unless otherwise noted.)



100µs/div

Pin Description

1	C1P	Transfer Capacitor 1 Positive Connection
2		
	EN2	Enable, Dimming Control Input 2. EN2 and EN1 control shutdown, 1/3 current, 2/3 current, and full current (see Table1).
3	GND	Analog Ground. Connect directly to the exposed paddle underneath the IC.
4	LED5	LED5 Cathode Connection. Current flowing into LED5 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED5 is high impedance during shutdown.
5	LED4	LED4 Cathode Connection. Current flowing into LED4 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED4 is high impedance during shutdown.
6	LED3	LED3 Cathode Connection. Current flowing into LED3 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED3 is high impedance during shutdown.
7	LED2	LED2 Cathode Connection. Current flowing into LED2 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED2 is high impedance during shutdown.
8	LED1	LED1 Cathode Connection and Charge-Pump Feedback. Current flowing into LED1 is 230 times the current flowing out of SET. The charge pump regulates the voltage on LED1 to various voltages depending upon the status of EN1 and EN2 (see Table 1). Grounding LED1 forces OUT to operate at 5V while LED2–LED5 regulate the LED current to 230 x V _{SET} /R _{SET} . LED1 is high impedance during shutdown.
9	SET	Bias Current Set Input. The current flowing out of SET programs the bias current into each LED by $I_{LED_} = 230 \times I_{SET}$. VSET is internally biased to various voltages (see Table 1). Connect a resistor to GND to set the bias current as VSET/RSET. SET is high impedance during shutdown.
10	EN1	Enable, Dimming Control Input 1. EN1 and EN2 control shutdown, 1/3 current, 2/3 current, and full current (see Table 1).
11	PGND	Power Ground. Charge-pump switching current flows through this pin. Connect to GND and system ground as close to the MAX1570 and the input bypass capacitor as possible.
12	C1N	Transfer Capacitor 1 Negative Connection
13	IN	Supply Voltage Input. Bypass IN to PGND with a 1µF ceramic capacitor. The input voltage range is 2.7V to 5.5V. IN is high impedance during shutdown.
14	C2P	Transfer Capacitor 2 Positive Connection
15	OUT	Charge-Pump Output. Bypass to PGND with a 4.7µF ceramic capacitor as close to the IC as possible. Connect to the anodes of all the LEDs. OUT is high impedance during shutdown.
16	C2N	Transfer Capacitor 2 Negative Connection
_	EP	Exposed paddle. Connect to GND.

Detailed Description

The MAX1570 is a complete charge-pump buck/boost converter requiring only four small ceramic capacitors. The MAX1570 utilizes a proprietary 1x/1.5x fractional charge-pump topology to drive up to five white LEDs with regulated constant current for uniform intensity. The MAX1570 operates with a 1MHz fixed frequency. An external resistor (RSET) programs the full-scale LED current, while two digital inputs control on/off and provide brightness control.

Output Regulation

Soft-Start

The MAX1570 operates in 1x charge-pump mode until just above dropout. Then the MAX1570 switches to 1.5x charge-pump mode to regulate the voltage at LED1 and maintain constant LED brightness even at very low battery voltages. Using this topology, there is no LED brightness change during the 1x/1.5x switchover, which guarantees no flicker on the display. The switchover scheme has low hysteresis, minimizing operation in the less efficient 1.5x mode. The 1x mode produces almost no ripple, while the 1.5x mode regulates the output voltage by controlling the rate at which the transfer capacitors are charged. In this way, the switching frequency remains constant for reduced input ripple and stable noise spectrum.

The MAX1570 includes soft-start circuitry to limit inrush current at turn-on. When starting up with an output voltage that is not near the input voltage, the output capacitor is charged directly from the input with a DAC ramped current source (with no charge-pump action) until the output voltage is near the input voltage. Once this occurs, the charge pump determines if 1x or 1.5x mode is required. In the case of 1x mode, the soft-start is terminated and normal operation begins. In the case of 1.5x mode, soft-start operates until LED1 reaches regulation. In case of an overload condition, soft-start repeats every 2.1ms. If the output is shorted to ground, the output current is limited by the MAX1570 fractional-switching technique and then the device hits thermal shutdown once the die temperature reaches -160°C.

True Shutdown Mode

When EN1 and EN2 are grounded, the MAX1570 is in shutdown, and the charge pump examines whether the input voltage is greater than or less than the output voltage and shorts the transfer capacitor nodes to either IN or OUT as necessary. The output is high impedance in either case.

Thermal Shutdown

The MAX1570 includes a thermal-limit circuit that shuts down the IC at about 160°C. Turn-on occurs after the IC cools by approximately 20°C.

Setting the Output Current

SET controls the LED bias current. Current flowing into LED1, LED2, LED3, LED4, and LED5 is 230 times greater than the current flowing out of SET. Set the output current as follows:

$$I_{LED_{-}} = 230 \times \left(\frac{V_{SET}}{R_{SET}}\right)$$

where $V_{SET} = 0.2V$, 0.4V, or 0.6V (depending upon EN1 and EN2, see Table 1), and R_{SET} is the resistor connected between SET and GND (see the *Typical Operating Circuit*).

Applications Information

Dimming Using EN1 and EN2

Use EN1 and EN2 inputs as a digital 2-bit number to control on/off, 1/3, 2/3, and full current (see Table 1). EN1 and EN2 control the voltage at SET (V_{SET}). Adjusting the SET voltage controls the current (I_{SET}) through the SET resistor (R_{SET}). Increasing V_{SET} or reducing R_{SET} increases I_{SET}, which then increases the LED current (I_{LED}).

The charge-pump feedback threshold at LED1 is increased as the current is increased to prevent dropout in the current regulators while improving efficiency at lower current settings. LED1 is regulated at 0.2V, 0.3V, or 0.4V when EN1 and EN2 are adjusted for 1/3, 2/3, or full current, respectively (see Table 1). A higher threshold improves LED-to-LED current matching, while a lower threshold improves efficiency by allowing the 1x mode at lower input voltages.

Dimming Using PWM into EN1

Use EN2 for shutdown and drive EN1 with a PWM signal. Current can be varied from 1/3 to full. The waveforms in the *Typical Operating Characteristics* show the response time of dimming. EN2 keeps the part on, eliminating any soft-start delay that would impede PWM control, allowing a PWM frequency up to 5kHz (Figure 1).

Dimming Using a Filtered-PWM Signal

Use a high-frequency PWM signal to drive an R-C-R filter on the SET pin (Figure 2). A 0% PWM duty cycle corresponds to 20mA/LED, while a 100% PWM duty cycle corresponds to 0mA/LED. At PWM frequencies above 5kHz, C3 may be reduced.

MAX1570

Table 1. Enable Input Modes

EN_ INPUT LOGIC LEVELS	MODE	LED CURRENT
EN1 = 0, EN2 = 0	Shutdown mode	0
EN1 = 0, EN2 = 1	On, V _{SET} = 200mV, LED1 threshold = 200mV	1/3
EN1 = 1, EN2 = 0	On, V _{SET} = 400mV, LED1 threshold = 300mV	2/3
EN1 = 1, EN2 = 1	On, $V_{SET} = 600 \text{mV}$, LED1 threshold = 400 mV	Full

Table 2. Capacitor Selection

OUTPUT (mA)	C _{IN} (µF)	C1 (µF)	C2 (μF)	Со т (µF)
40	1	0.22	0.22	4.7
80	1	0.47	0.47	4.7
150	1	1.0	1.0	4.7

Table 3. Capacitor Manufacturers

COMPONENT NAME	VALUE (µF)	MANUFACTURER	PART NO.	DESCRIPTION
CIN	1	Taiyo Yuden	JMK107BJ105MA	1µF ±20%, 6.3V X5R ceramic capacitor (0603)
COUT	4.7	Taiyo Yuden	JMK212BJ475MG	4.7µF ±20%, 6.3V X5R ceramic capacitor (0805)
	1	Taiyo Yuden	JMK107BJ105MA	1µF ±20%, 6.3V X5R ceramic capacitor (0603)
C1 and C2	0.47	Taiyo Yuden	LMK107BJ474MA	0.47µF ±20%, 10V X5R ceramic capacitor (0603)
	0.22	Taiyo Yuden	LMK107BJ224KA	0.22µF ±10%, 10V X7R ceramic capacitor (0603)

White LED Current Regulator with 1x/1.5x **High-Efficiency Charge Pump Component Selection** Typical external component values are shown in Table

Maximum power dissipation occurs around 4.2V on IN and 4.0V at OUT with maximum load current.

$$P_{D} = \left[\left((1.5 \times V_{IN}) - V_{OUT} \right) + 0.4 V \right] \times 120 \text{mA} = 324 \text{mW}$$

At higher IN voltages this device switches to 1x mode and power dissipation is lowered.

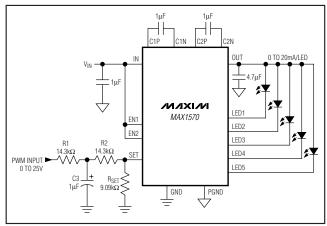


Figure 2. Dimming Using Filtered-PWM Signal

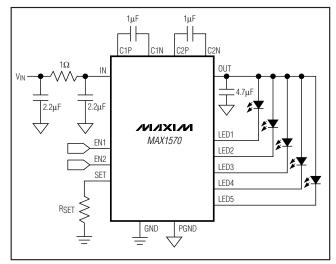


Figure 3. C-R-C Filter Reduces Input Ripple

Chip Information

TRANSISTOR COUNT: 3187

MAX1570

Input Ripple

2 and Table 3.

For LED drivers, input ripple is more important than output ripple. Input ripple depends on the source supply's impedance. Adding a lowpass filter to the input further reduces input ripple. Figure 3 shows a C-R-C filter used to reduce input ripple to less than 2mVP-P when driving a 75mA load. Alternately, increasing CIN to 2.2µF or 4.7µF yields input ripple of 17mVP-P or 9mVP-P, respectively, with only a small increase in footprint. The 1x mode has very low input ripple.

PC Board Layout and Routing

The MAX1570 is a high-frequency switched-capacitor voltage regulator. For best circuit performance, use a solid ground plane and place CIN and COUT as close to the MAX1570 as possible. Also, place their ground tails close together. Connect PGND and GND directly under the IC to the exposed paddle, and connect CIN and COUT as close as possible to PGND. The input supply connections should be short; if this is not possible, an additional input supply filter capacitor (tantalum or electrolytic) may be required. Refer to the MAX1570 EV kit for a good layout example.

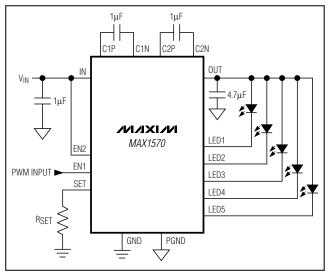
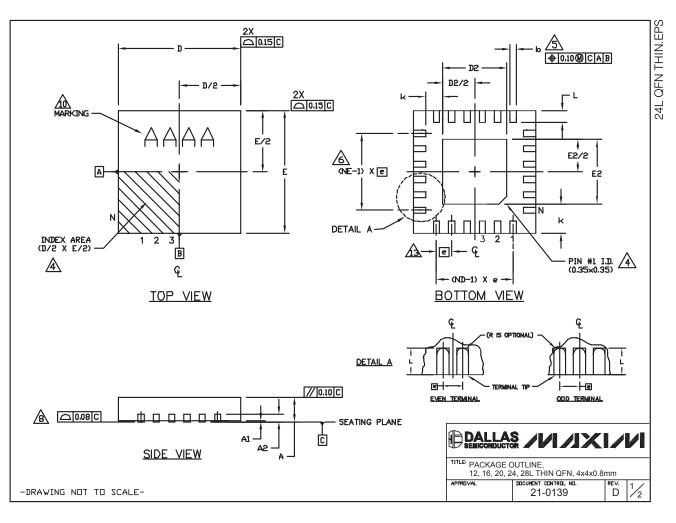


Figure 1. Dimming Using PWM Signal into EN1

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



MAX1570

M/IXI/M

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

					MDN	DIME	INSI	INS								E	EXPOSED PAD VARIAT						
PKG	12	2L 4×	4	16	5L 4x	4	20	L 4x	4	24	4L 4>	(4	28	3L 4×	:4	PKG.		D2			E2	_	DOWN BONDS
REF.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MEN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	ZITI	MIN.	NDM.	MAX.	MIN.	NOM.	MAX.	ALLOVE
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	T1244-2	1.95	2.10	2.25	1.95	2.10	2.25	ND
A1	0.0	0.02	0.05	0.0	20,0	0.05	0,0	9.02	0.05	0.0	0.02	0.05	0,0	20,0	0.05	T1244-3	1.95	2.10	2.25	1.95	2.10	2.25	YES
A2	0	.20 RE	F	0	20 RE	F	0.	20 RE	F	0	.20 RE	F	0	20 RE	F	T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	ND
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30	0.15	0.20	0.25	T1644-2	1.95	2.10	2.25	1.95	2.10	2.25	ND
D	3.90		4,10	3.90	4.00	4.10		4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	YES
E	3.90		4.10	3.90	4.00	4.10		4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	T1644-4	1.95	2.10	2.25	1.95	2.10	2.25	ND
e	<u> </u>	280 85			.65 BS			50 BS			.50 BS	1		40 BS		T2044-1	1.95	2.10	2.25	1.95	2.10	2.25	ND
ĸ	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	T2044-2	1.95	2.10	2.25	1.95	2.10	2.25	YES
L	0.45		0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50	T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	ND
N	<u> </u>	12			16			20			24			28		T2444-1	2.45	2.60	2.63	2.45	2.60	2.63	ND
ND		3			4			5			6			7		T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	YES
NE Jedec Var.	<u> </u>	3			4 VGGC			5		<u> </u>	6	•		7 VGGE		T2444-3	2.45	2.60		2.45	2.60	2.63	YES
Var.		WGGB			WUGU		<u> </u>	/GGD-	1		WGGD-	-2		WOOL		T2444-4 T2844-1	2.45		2.63 2.70	2.45 2.50	2.60 2.60	2.63 2.70	ND
<u>_</u>	JESD 9 The ZC DIMENS	5-1 SP NE IND	PP-012 NCATED APPLIE	2. Deta . The	ils of Termin	₩L #1	IDENTI	identi Ter M	ifier Af Iay Bie	re opt Either	ional, R A MC	BUT M	ust be Marke	ED FEA	ED WITH TURE. 0.30 mi								
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—	DRAWIN IARKING	ig con ; is fo	Forms Ir Pac	t o je Kage (DRIENT	1 0220, ATION R 0.08mm	EXCEP1	FOR	T2444-						44-1.								
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Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.З, офис 1107

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